# PRODUCT SPECIFICATION

CS0802B-D-BSXTSWN-100

V1.0

**April 3, 2009** 

Easterntronic LCD Group

## **REVISION RECORD**

REV	DESCRIPTION	PAGE	DATA
V1.0	First release		Apr 3, 2009

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1. Type Number and Description

Type Number: CS0802B-D-BSXTSWN-100

Description: 8 Characters x 2 Lines

LCD Panel: Blue-STN, Negative, Transmissive

Operating Temperature:  $-20^{\circ}\text{C} - 70^{\circ}\text{C}$ 

Storage Temperature:  $-30 \, ^{0}\text{C} - 60 \, ^{0}\text{C}$ 

Viewing angle: 6H

BackLight Mode: Side

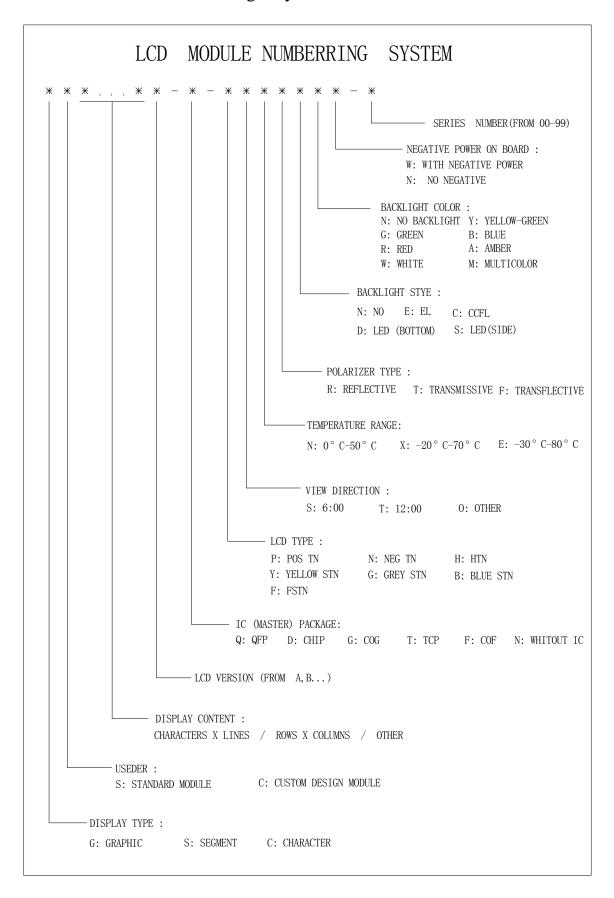
BackLight Color: White

Controller: ST7066U-OA OR Equivalent

IC Package: Bonding

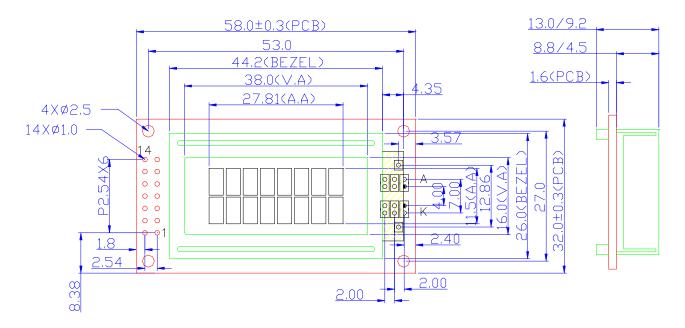
Logic Voltage: 5.0V

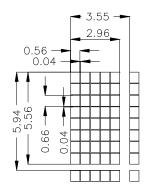
### 2. LCD Module Numbering System



## **3.** Mechanical Specifications:

		1
ITEM	STANDARD VALUE	UNIT
NUMBER OF CHARACTERS	8 CHARACTERS X 2 LINES	
CHARACTER FORMAT	5 X 7 DOTS with CURSOR	
MODULE DIMENSION	58.0(W) X 32.0(H) X13.0(T)	mm
EFFECTTVE DISPLAY AREA	38.0(W) X 16.0(H)	mm
CHARACTER SIZE	2.96(W) X 5.56(H)	mm
CHARACTER PITCH	3.55(W) X 5.94(H)	mm
DOT SIZE	0.56(W) X 0.66(H)	mm
DOT PITCH	0.6W) X 0.7(H)	mm
APPROX WEIGHT	TBD	g
LCD TYPE	BLUE; STN	
DUTY AND BIAS	1/16 DUTY; 1/5 BIAS	
VIEWING DIRECTION	6:00	
BACK LIGHT	White,	





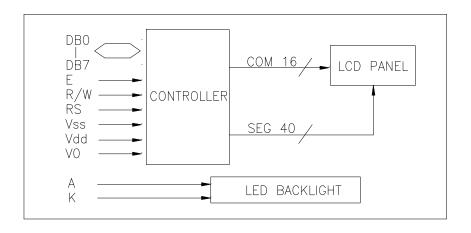
\* Remark : Non-specificed tolerance refers this model. ( $\pm 0.2$ mm)

## 4. Electrical Block Diagram

### 4.1 PINS DEFINITION

PIN	SYMBOL	FUNCTION					
1	Vss	Power Supply(GND)					
2	Vdd	Power Supply(+5V)					
3	Vo	Contrast Adjust					
4	RS	Instruction/Data Register Select					
5	R/W	L: Write; H: Read					
6	Е	Enable Signal					
7-14	DB0-DB7	Data Bus Line					
-	A	Power Supply for LED B/L(+)					
	K	Power Supply for LED B/L(-)					

## 4.2 ELECTRICAL BLOCK DIAGRAM



## 4.3 DISPLAY CHARACTER ADDRESS CODE

Disply position	1	2	3	4	5	6	7	8
	00	01	02	03	04	05	06	07
DDRAM address	40	41	42	43	44	45	46	47

## 5. Absolute Maximum Ratings

## 5.1 Electrical Maximum Ratings (Ta=25deg C)

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Supply Voltage (Logic)	Vdd – Vss	-	0	7.0	V
Supply Voltage (LCD Drive)	Vdd – V0	-	0	11.5	V
Input Voltage	Vi	-	-0.3	Vdd +0.3	V

#### 5.2 Environmental Conditions

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Operating Temp	Topr	Dry	-20	70	deg C
Storage Temp	Ttsg	Dry	-30	80	deg C

## **6**. Electrical Specifications

### 6.1 Electrical Characteristics at Ta=25 deg C, Vdd = 5V + / - 5%

ITEM	SYMBOL	CONDITIO N	MIN	TY P	MAX	UNI T
Supply Voltage (logic)	Vdd-Vss	-	4.5	5	5.5	V
Supply Voltage (LCD)	Vdd-V0	Vdd = 5V	4.5	4.7	5.0	V
Input signal voltage (for E, DB0-7,R/W,RS)	V-ih	"H" level	0.7V DD	-	Vdd	V
(101 E, DB0-7,R/W,RS)	V-il	"L" level	0	-	0.6	V
Supply Current (logic)	Icc	-	-	1	1.2	mA
Supply Current (LCD)	Io	-	0.15	0.22	0.27	mA
*Supply Voltage (LED )	V-bl	-	2.9	3.1	3.3	V
*Supply Current (LED )	I-bl	-	-	30	50	mA
*Peak forward current(B/L)	Ifp	I mseo pulse 10% Duty Cycle	-	-	120	mA
*Power dissipation(B/L)	Pd	_	-	ı	124	mW

<sup>\*</sup>For operation above  $25\,^{\circ}\text{C}$ , the If \ Ifp&Pd must be derated, the current derating is -0.72 mA/  $^{\circ}\text{C}$  for DC drive and -1.72mA/ $^{\circ}\text{C}$  for pulse drive,the power dissipation is -2.23 mW / $^{\circ}\text{C}$ .The Blacklight working current must not more than 60% of the Ifmax or Ifpmax according to the working temperature.

## 6.2 TIMING SPECIFICATIONS at Ta = 25 deg C, Vdd = 5V+/-10%, Vss =0V

### 6.2.1 Write mode

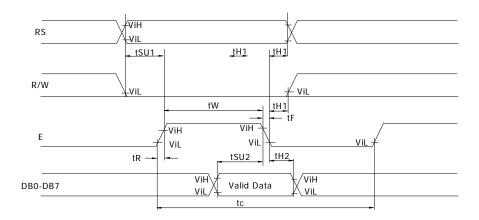
ITEM	SYM BOL	MIN	MAX	UNIT
E cycle time	tc	1200	-	ns
E rise time	tR	-	20	ns
E fall time	tF	-	20	ns
E-pulse width (H, L)	tw	140	-	ns
R/W and RS set-up time	tsul	0	-	ns
R/W and RS hold time	tH1	10	-	ns
Data set-up time	tsu2	40	-	ns
Data hold time	tH2	10	_	ns

### 6.2.2 Read mode

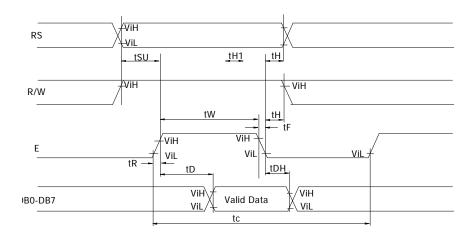
ITEM	SYBOL	MIN	MAX	UNIT
E cycle time	tc	1200	-	ns
E rise time	tR	-	20	ns
E fall time	tF	-	20	ns
E-pulse width (H, L)	tw	140	-	ns
R/W and RS set-up time	tsu	40	-	ns
R/W and RS hold time	tH	10	-	ns
Data output delay	tD	-	120	ns
Data hold time	tDH	5	-	ns

## 6.2.3 Timing Diagram

## WRITE MODE TIMING DIAGRAM

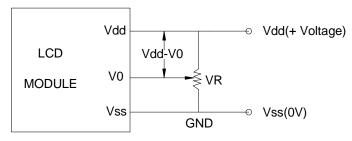


#### READ MODE TIMING DIAGRAM



## Example of power supplye

It is recommended to apply a potentiometer for the contrast adjust due to the tolerance of driving voltage and its temperature dependence.



Vdd - V0: LCD Driving Voltage

VR: 10K - 20K

### **8.** Electro-Optical Characteristic

ITEM	SYMB OL	CONDI TION	MIN.	TYP.	MAX.	UNIT	REF.
Contrast	CR	25℃		12			Note1
Rise Time	tr	25℃		160	240	ms	Note2
Fall Time	tf	25℃		100	150	ms	note 2
Viewing Angle	θ 1- θ 2	25℃	1	1	60	DEG	Note 3
	Ø1, Ø2		-40		40		
Frame Frequency	Ff	25℃		70		Hz	note 2

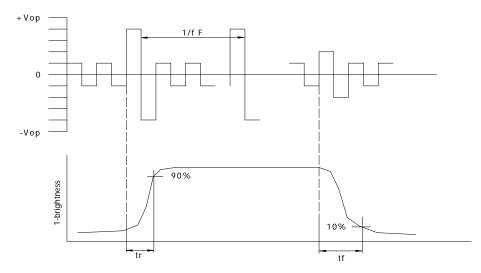
V1.0

## **Note(1): Contrast ratio is defined under the following condition:**

brightness of selected condition brightness of non-selected condition CR=

- (a). Temperature----25C
- (b). Frame Frequency-----64Hz
- (c). Viewing angle-----  $\theta = 0$ ,  $\emptyset = 0$
- (d). Operating Voltage---4.7V

### **Note(2): definition of response time:**

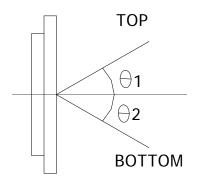


#### **Condition:**

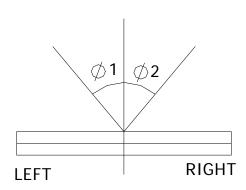
- (a). Temperature-----25C
- (b). Frame Frequency-----64Hz
- (c). Viewing angle----  $\theta = 0$ ,  $\emptyset = 0$
- (d). Operating Voltage---4.7V

## **Note(3): definition of view angle:**

**TOP-BOTTOM DIRECTION** 



#### **RIGHT-LEFT DIRECTION**

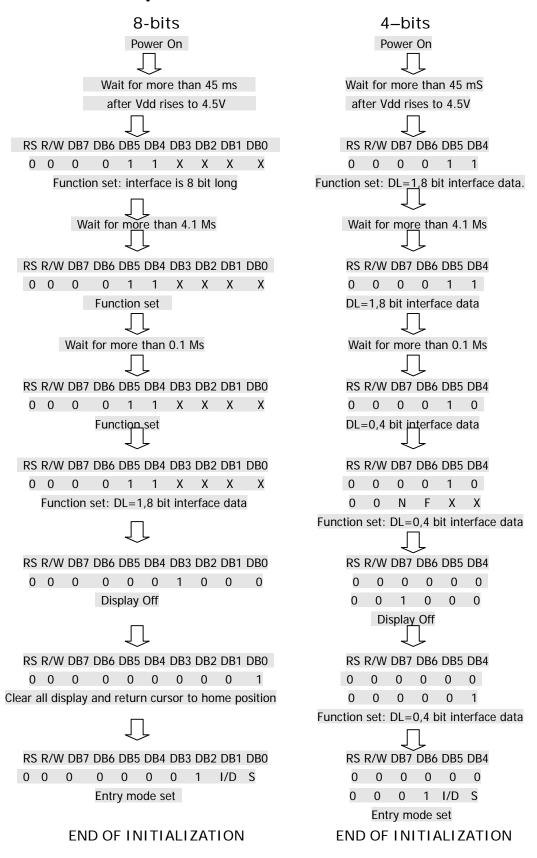


## 9. Instruction Table

Instruction				lns	struct	ion C	ode				Description	Execution time
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		(fosc= 270KHz)
Clear	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set	1.52 ms
Display											DDRAM address to '00H' from	
											AC.	
Return Home	0	0	0	0	0	0	0	0	1	Х	Set DDRAM address to '00H'	1.52 ms
											from AC and return cursor to its	
											original position if shifted.	
											The contents of DDRAM are not	
											changed.	
Entry Mode	0	0	0	0	0	0	0	1	<u> </u>	SH	Assign cursor moving direction	37 µs
Set											and make shift of entire dispaly	
											enable.	
Display	0	0	0	0	0	0	1	D	С	В	Set display(D), cursor(C), and	37 µs
ON/OFF											blinking of cursor(B) on/off	
Control											control bit.	
Cursor or	0	0	0	0	0	1	S/C	R/L	Х	Х	Set cursor moving and display	37 μs
Display Shift											shift control bit, and the direction,	
											without changing DDRAM data.	
Function Set	0	0	0	0	1	DL	N	F	Х	Х	Set interface data length (DL: 4-	37 μs
											bit/8-bit), numbers of display line	
											(N: 1-line/2-line), display font	
											type(F:5X8 dots/5X11 dots)	
Set CGRAM	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address	37 μs
Address											counter.	
Set DDRAM	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address	37 μs
Address											counter.	
Read Busy	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation	0 μs
Flag and											or not can be known by reading	
Address											BF. The contents of address	
											counter can also be read.	
Write Data to	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM	43 µs
RAM											(DDRAM/CGRAM).	
Read Data	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM	43 µs
from RAM											(DDRAM/CGRAM).	

- "X" : don't care

#### 10. Initialization By Instruction



## 11. Software Examples

## 8-BIT OPERATION 8 characters X 2 lines

Function	RS RW D7 D6 D5 D4 D3 D2 D1 D0	DISPLAY DESCRIPTION
Power on delay		Initialization. No display appears.
Function set	0 0 0 0 1 1 0 0 X X	Sets 8-bit operation, 2-line display and
		5*7 dots character font.
Display OFF	0 0 0 0 0 0 1 0 0 0	Turn off display.
Display ON	0 0 0 0 0 0 1 1 1 0	Turn on display and cursor.
Entry Mode set	0 0 0 0 0 0 0 1 1 0	Set mode to increment the address by
		one and to shift the cursor to the right, at
		the time of write to the DD/CG RAM.
		Display is not shifted.
Write data to	1 0 0 1 0 0 1 1 1 1	O Write "O". Cursor incremented by one and
CG/DD RAM		shift to right.
Write data to	1 0 0 1 0 1 0 0 1 0	OR Write "R". Cursor incremented by one and
CG/DD RAM		shift to right
Write data to		ORIENT Write "I" "E" "N" "T".
CG/DD RAM		
Set DDRAM	0 0 1 1 0 0 0 0 0 0	ORIENT Set RAM address so that the cursor is
address		positioned at the head of the Second line
Write data to		ORIENT Write "D" "S".
CG/DD RAM		DS
Cursor or display	0 0 0 0 0 1 0 0 X X	ORIENT Shift only the cursor position to the left.
shift		DS
Write data to		ORIENT Write "I" "S" "P" "L" "A" "Y"
CG/DD RAM		DISPLAY

## 4-bit operation (4-bits 1 line)

Function	RS RW	D7 D	06 D!	5 D4	Display	Description
power on delay						Initialization. No display appears.
Frnction set	0 0	0	0 1	I 0		Sets to 4-bit operation. In this case, operation is handled as 8-bits by initialization,a nd Only this instruction completes with one write.
Frnction set	0 0	-	0 1 0 X	I 0		Sets 4 -bit operation, 1-line display and 5*7 dot character font. (number of display lines and character fontscannot be changed hence after.)
Display ON/OFF Control	0 0 0	0 1	0 0		_	Turn on display and cursor.
Entry Mode Set	0 0 0		0 0		_	Turn on display and cursor.
Write data to CG/DD/ARM	1 0 1 0	0 1	1 ( 1 1	) 0 I 1		Write "O". Curaor incrementer by one and shift to right.
	·				same as 8-bi	t operation

#### 12.Quality units

#### 12.1 Purpose

This standard for quality assurance should define the quality of LCD module products to customer by EASTERNTIONIC LCD GROUP.

#### 12.2 Scope

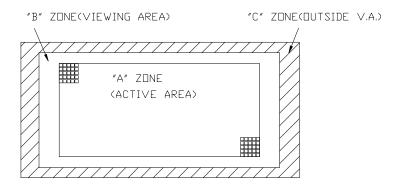
This document defines general provisions as well as inspection standards for LCD module supplied by EASTERNTIONIC LCD GROUP, except for those with special requirements from customer.

#### 12.3 Definition

#### 12.3.1 Definition of area

A Zone: Active area. B Zone: Viewing area

C Zone: Outside viewing area.



#### 12.3.2 Definition of size

Large size(L): 1~6 pcs LCD screens are cut out of from each 14"×16" mother glass. Middle size(M): 7~50 pcs LCD screens are cut out of from each 14"×16" mother glass. Small size(S): more than 50 pcs LCD screens are cut out of from each 14"×16" mother glass.

#### 12.4 Quality Specification

#### 12.4.1 Conditions of Cosmetic Inspection

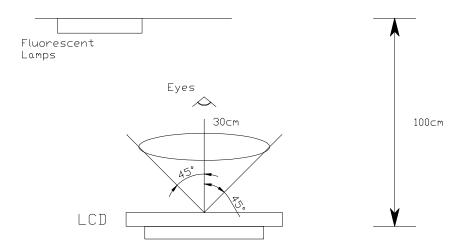
#### 12.4.1 Test should be conducted under the following conditions:

Ambient temperature :22 $\pm$ 5°C. Ambient humidity: 65 $\pm$ 20% RH

Ambient Luminance: 40-watt fluorescent lamp.

An appearance test should be conducted by human sight at approximately 30 cm distance

from the LCD module under fluorescent light. Distance between LCD and fluorescent lamps should be 100 cm or more. Viewing direction for inspection is 45° from vertical against LCD.



#### 12.4.1.2 When test the model of transmissive product must add the reflective plate.

#### 12.4.2 Sampling plan

Unless otherwise agreed in writing, the sampling inspection shall be applied to the incoming inspection of customer.

- Lot size: Quantity of shipment lot per model
- Sampling type: Normal inspection, single sampling
- Sampling Level: Level II
- Sampling table: GB/T2828.1.1(GB-national standard of China)

#### 12.4.3 Classification of defects and Acceptable quality level

Defects and classified as either a major or minor defect defined as bellows:

- Major defect: It is a defect that is likely to result in failure or to reduce materially the usability of the product for the intended function.
- Minor defect: It is a defect that will not result in functioning problem with deviation calssifiec.

The AQL for major and minor defects is defined as follows:

Partition	Definition	AQL
Major defect	Functional defective as product	0.4
Minor defect	Satisfy all functions as product but not satisfy cosmetic standard	1.0

#### 12.4.4 Applicable instrument

- LCD module tester
  - Multimeter
  - Caliper
  - Defect size filming standard

## 12.4.5 Inspection quality criterion

## 12.4.5.1 LCD panel part

The inspection specification as following list:

Classify	Item	Description of defects	Inspection	on criterion	Drawing specification
Major defect	1.Non-display	Product no function	Not	accept	
	2.LCD with wrong view direction`	Difference in Spec.	Not	accept	
	3.Segment missing	Part or all pattern do not light up	Not	accept	
	4.Occur high current	Current exceed designed value	Not	accept	
	5. LC leakage	LC does not fulfill the glass cell	Not	accept	
	6.Deviation from drawing	LCM Dimension difference from drawing and over tolerance	According to dimensions noted in the specification		
	7.Wrong type applied	Wrong polarizer attachment	Not	accept	
		Pin attached wrong type applied	Not accept  Not accept		
	8.Incorrect pins quality	Pin attached wrong quantity applied			
Minor defect	9.Pattern deformation	Segment fatter or smaller	Dimension (mm) A≤0.1	Acceptable number  Not count (Should not be connected to next dot)	

			0.10 <a≤0.15 B≤0.10</a≤0.15 	1 pc / dot(only segment)or less 2 pcs / cell or less (Should not be connected to next dot)	
Minor defect	10.Pinholes	Black spot/white spot at activated state	Im distance enlarge under 2. Middle sind Diameter (mr. Φ≤0.15 0.15<Φ≤0.25 0.25<Φ≤0.35 Φ>0.35 3. Small size Diameter (mr. Φ≤0.15 0.15<Φ≤0.25 Φ≤0.30 Φ>0.30 Φ>0.30 Φ>0.30 4. For the accept is defect is equal to lattice's 5. Only allow one segment of the end of the	an't be found at the and will not be and will not be earned with a count and a count and a count and a count area of a count area	$\Phi = (X+Y)/2$

Г	11 Dlamiahas	Dlook anot/deat	Docitivo nonele	
	11.Blemishes	Black spot/dust	Positive panel:	<b>\</b>
	and foreign	on on	1.A zone	
	matters	LCD(non-display	- Large size LCD	▶
		)	Accept if can't find at 1m	
			distance and will not enlarge	A (M. M.) (0
			under electronic test:	$\Phi = (X+Y)/2$
			-Middle size LCD	
			Diameter(mm) Accept QTY	
			$\Phi$ ≤ 0.15 Not count	
			$0.15 < \Phi \le 0.25$ 3	
			0.25<Φ≤ 0.35 1	
			$\Phi > 0.35$ 0	
			-Small size LCD	
			Diameter(mm) Accept QTY	
			$\Phi \le 0.15$ Not count	
			$0.15 < \Phi \le 0.25$	
			$\Phi > 0.30$ 0	
			2.B zone	
			1.5 times of acceptable	
			largest diameter size of Zone	
			A	
			3.C zone	
			Notcount.	
			N	
			Negative panel:	
			1. A zone	
			-Large size LCD	
			Diameter(mm) Accept QTY	
			Φ≤ 0.15 Not count	
			$0.15 < \Phi \le 0.30$ 4	
			$0.30 < \Phi \le 0.50$	
			$\Phi > 0.50$ 0	
			-Middle&small size LCD	
			Diameter(mm) Accept QTY	
			$\Phi \le 0.15$ Not count	
			0.15<Φ≤0.25 3	
			$\Phi > 0.25$ 0	
			2. B zone	
			1.5 times of acceptable largest diameter size of Zone	
			A	
			3.C zone	
			No count	
			The nearest diatance	
			allowed between two black	
			spot is 20mm	
			spot is zoniiii	

		·	
12.Black	Scratch on glass	Positive panel:	
lines and	or polarizer	1.A zone	
scratches	surface.And	- Large size LCD	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
	foreign linear	Accept if can't find at 1m	
	matters in LCD	distance and will not enlarge	
		under electronic test.	
		under electronic test.	
		-Middle size LCD	
		Diameter(mm) Accept QTY	
		W≤ 0.02 Not count	
		$0.02 < W \le 0.03, L \le 4$ 2	
		$0.03 < W \le 0.05, L \le 3$ 2	
		$0.02 < W \le 0.03, L > 4 $ 0	
		$0.03 < W \le 0.05, L > 3 $ 0	
		W>0.05 As the spot criteria.	
		-Small size LCD	
		Diameter(mm) Accept QTY	
		$W \le 0.02$ Not count	
		0.02< W≤ 0.03,L ≤4 2	
		$0.03 < W \le 0.05, L \le 2$	
		0.02< W≤ 0.03,L >4 0	
		$0.03 < W \le 0.05, L > 2$ 0	
		W>0.05 As the spot criteria.	
		The state of the s	
		2.B zone	
		1.5 times of acceptable largest	
		diameter size of Zone A	
		3.C zone	
		Notcount.	
		Negative panel:	
		1. A zone	
		-Large size LCD	
		Diameter(mm) Accept QTY	
		$W \le 0.02$ Not count	
		$0.02 < W \le 0.03, L \le 5$ 3	
		$0.03 < W \le 0.05, L \le 4$ 2	
		$0.02 < W \le 0.03, L \le 7$ 2 $0.02 < W \le 0.03, L > 5$ 0	
		$0.02 < W \le 0.05, L > 3$ $0.03 < W \le 0.05, L > 4$ 0	
		<u> </u>	
		W>0.05 As the spot criteria.	
		-Middle size LCD	
		Diameter(mm) Accept QTY	
		W≤ 0.02 Not count	
		$0.02 < W \le 0.03, L \le 4$	
		1	
		$0.03 < W \le 0.05, L \le 2 \qquad 2$	

			0.02< W≤ 0.03,L >3 0	
			$0.02 < W \le 0.05, L > 3$ $0.03 < W \le 0.05, L > 2$	
			W>0.05 As the spot criteria.	
			-Small size LCD	
			Diameter(mm) Accept QTY	
			$W \le 0.02$ Not count	
			$0.02 < W \le 0.03, L \le 3$	
			$0.03 < W \le 0.05, L \le 3$ 1	
			$0.02 < W \le 0.03, L \ge 3$ 0	
			$0.03 < W \le 0.05, L > 2$ 0	
			W>0.05 As the spot criteria.	
			W > 0.05 As the spot effecta.	
			2. B zone	
			1.5 times of acceptable largest	
			diameter size of Zone A	
			3.C zone	
			Not count	
			The nearest diatance allowed	
			between two defects is 20mm	
Mintor	13. Scratch	PI coating	The visible scratch of A zone can	
defect	on PI coating	scratched	not be accepted at 30cm view	
			distance.	
Mintor	14. Rainbow	Arches,circular	According to the limit specimen	
defect		or parallel		
		colorful spread		
3.51	12 - 22			
Mintor	15. Bubbles	Bubbles or	A zone:The visible defect can not	
defect	or wrinkles in	wrinkles	be accepted at 30cm view	
	polarizer	between	distance.	
		polarizer and	B zone: Not count	
3.61	16 D 11	glass		
Mintor	16. Position	Wrong polarizer	Polarizer protruding from edge of	
defect	of polarzer	attachment in	glass and exceeding/within the	
	attachment	position or	maximum external dimension of	
3.6	15 11	dimension	LCD	
Mintor	17. Ink	17.1 Ink	Not accept	
defect	printing	line/pattern		
	defect	broken		

V1.0

		17.2 Ink pattern/line jagged  17.3 Light leakage  17.4 Ink printing pattern/line uneven	less than width, o specimen When white lig of pinho printing to the pin Reject if than 1/2V	Accept if the thick or thin part is less than equal to 25% segment width, or according to the limit specimen  When activated with current white light appears in the position of pinhole or scratch due to ink printing misalignment. According to the pinhole specification.  Reject if the thick or thin in more than 1/2W.  Reject when W1-W2≤1/3W			W1 W2
Mintor defect	18. Pin defect	18.1 Corrosion or foreign material on terminal legs  18.2 Pin deviation over tolerance	plating on bott legs.Not	incomir ,damage(i damaged) om glas accept. ng to the s	ncludin ),excess s or	epoxy terminal	,
Mintor defect	19. Chipped glass on	19.1 Chip in lead contact	a a≤5mm	b	C	accept QTY	
	comer	area.	L>5m m	b≤W	c≤T	3	ITO
			a <l L&lt;5m m</l 	b≤W	c≤T	3	T T T
		19.2 Others	Not exc width of		c≤T	3	lo control of the con
Mintor defect	20. Glass	chip on edge	a	b	c	accept QTY	1 × 2 ° ° ° ° ° ° ° ° ° ° ° ° ° ° ° ° ° °
			a≤5mm	Not exceed 1/2 width of seal	c≤T	3	

Mintor	21. Clipped electrode pad	21.1Glass chip on ITO edge	a	b	С	accept QTY	ITO
defect			a≤4mm (and not exceed 4 ITO termina 1	b≤W/4	c≤T	3	
		21.2 Glass chip on ITO back	a	b	С	accept QTY	
			a≤5mm	b≤W/3	c≤T	3	The state of the s
Mintor defect	22. Mechanical	Extended crack inspector shall	b		accept	QTY	
	damage	attempt to remove the chip with tweezers,re-eval uate if the remaining defect is still a crack or a chip	b≤W/4		2		
Mintor defect	23.Gla	ass cracks	Not acce	pt	l		

#### Remark:

The minimum space between any 2 defects(spot,dirt) should more than 20mm, and max. allowed defect QTY in total:

Large size LCD: Zone A≤ 5/unit, Zone B≤ 5/unit;

Middle size LCD: Zone  $A \le 3/unit$ , Zone  $B \le 3/unit$ ;

Small size LCD: Zone  $A \le 2/unit$ , Zone  $B \le 2/unit$ ;

## 12.4.5.2 Other part

The inspection specification as following list:

NO.	Items	Criterion of defects	AQL
1	Backlight	<ol> <li>Lumination source flickers.</li> <li>Using spot, lines and contamination standard of LCD to judge the spots or scratches defect on backlight.</li> </ol>	Major Minor
		3. Not allow unlighted on backlight.	
		4. Colour and luminance of backlight should correspond its specification.	Major Major
2	PCB,COB	1.COB seal may not have pinholes larger than 0.2mm or contamination.	Minor
		<ul><li>2.COB seal surface may not have pinholes through to the IC.</li><li>3. The height of COB should not exceed the height indicated in the assembly diagram.</li></ul>	Minor Major
		4. Beyond 2mm of the seal area, there may not have sealant on the PCB.	Minor
		5.No oxidation or contamination on PCB connector.	Minor
		6.Parts on PCB should correspond the characteristic, and not allow wrong parts, missing parts or additional parts.	Major
		7. The jumper on the PCB should correspond to the characteristic.	Minor
		8.The solder which gets on bezel,LED pad,zebra pad or screw hole pad should be smoothed down.	Major
		1. No unmelted solder pastes on the PCB.	Minor
3	Soldering	2. No cold solder joints, solder connection missing, oxidation of solder.	Minor
		3. No short circuits in components on PCB.	Minor
4	General Appearance	1. No oxidation, contamination, curves, cracks or bends on interface Pin of TCP.	Minor
		2. No solder residue or solder balls on product.	Minor
		3. The IC on TCP may not be damaged.	Major
		4. The residual rosin or tin oil of soldering(component or chip component) is not turned into brown or black colour.	Minor
		5. Packing method correspond the specification.	Major
		6. Dimension and structure correspond the specification sheet.	Major
		7. No dirt and break on the heat seal.	Major

## 12.5 Reliability

The LCD module shall not fail the following reliability test.

Item	Condition	Criterion	
High temperature operation	$+70^{\circ}\text{C} \pm 2^{\circ}\text{C}$ , 8 ho		
Low temperature	-20°C ±2°C, 8 ho	urs	1.Total current
operation			consumption
Humidity	Operation	$40 \degree \pm 2 \degree ,93\% \pm 2\%$ RH,8 hours	should be below double of initial
	Storage	$40 \degree \pm 2 \degree ,93\% \pm 2\%$ RH, 24 hours	value.  2.Cosmetic defects
High temperature storage	+80°C±2°C, 101	nours	should not be happened
Low temperature storage	-30°C±2°C, 10 h	ours	
Thermal shock storage	-20°C~+70°C 60min~60min, 5 cy	vcles	
Vibration test		mm,frequency:50Hz,30min	
Shock test	To be measured aft 80cm high on the c state.(weight≥15k Weight<15Kg,dro		
	G B 60/8	Dropping method corner dropping A corner: once Edge dropping B,C,D edge: once Face dropping E,F,G face: once	

Remark: The function test shall be conducted after 4 hours storage at the normal temperature and humidity after removed from the test chamber.

#### 13. PRECAUTION FOR USING LCM

#### 1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handing,

- (1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degredation, polarizer peel off or bubble.
- (2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface. Wipe gently with cotton. Chamois or other soft material soaked in petroleum benzin.
- (3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.
- (4). Glass can be easily chipped or cracked from rough handing. especially at corners and edges.
- (5). Do not drive LCD with DC voltage.

#### 2. Liquid Crystal Display Modules

#### 2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

- (1). Do not tamper in any way with the tabs on the tabs on the metal frame.
- (2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattem.
- (3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).
- (4). When mounting a LCM make sure that the PCB is not under any tress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- (5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing piels.

#### 2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

- (1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- (2). The modules should be kept in antistatic bags or other containers resistant to static for storage.
- (3). Only properly grounded soldering irons should be used.

- (4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.
- (5). The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive ( rubber) mat is recommended.
- (6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

#### 2.3. Soldering

- (1). Solder only to the I/O terminals.
- (2). Use only soldering irons with proper grounding and no leakage.
- (3). Soldering temperature: 280  $^{\circ}\text{C} \pm 10^{\circ}\text{C}$
- (4). Soldering time: 3 to 4 sec.
- (5). Use eutectic solder with resin flux fill.
- (6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

#### 2.4. Operation

- (1). The viewing angle can be adjusted by varying the LCD driving voltage V0.
- (2). Driving voltage should be kept within specified range; excess voltage shortens display life.
- (3). Response time increases with decrease in temperature.
- (4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".
- (5). Mechanical disturbance during operation (such as pressing on the viewing area) nay cause the segments to appear "fractured".

#### 2.5. Storage

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

#### 2.6. Limited Warranty

Unless otherwise agreed between EASTERNTRONIC and customer, EASTERNTRONIC will replace or repair any of its LCD and LC, which is found to be defective electrically and visually when inspected in accordance with EASTERNTRONIC acceptance standards, for a period on one year fron data of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of EASTERNTRONIC is limited to repair and/or replacement on the terms set forth above. EASTERNTRONIC will not responsible for any subsequent or consequential events.

14. Declaration of conformity regarding the limitation of dangerous substances

## 深圳易事通液晶显示模块有限公司

#### SHENZHEN EASTERNTRONIC LCM CO., LTD.

4F, B3 Building, FuYuan Industrial Zone, FuYong Town,

#### BaoAn District, ShenZhen, P.R. China

DECLARATION OF CONFORMITY REGARDING THE LIMITATION OF DANGEROUS SUBSTANCES

WE, SHENZHEN EASTERNTRONIC LCM CO., LTD,

Declare that the product of CSO802B-D-BSXTSWN-100 complies with:

The directive 2002/95/EC Dated 2003/01/27 regarding the limitation of dangerous substances, in particular to clause 4 which forbids the use of the following elements:

- Lead
- Mercury
- Cadmium
- Hexavalant chromium
- Polybrominated biphenyls
- Polybrominated diphenylethers

And to the annex which points out the exempted implementations  $\square$  To the directive 73/23/eec dated 1973/02/19 and the standard EN60335-1 regarding prohibition of following elements:

- Oils containing polychlorinated biphenyl
- Asbestos
- Radioactive substances

Name: Ding

SHENZHEN EASTERNTRONIC LCM CO., LTD.

Issued on April 3 2009

According with the proposal of Technical Adaption Committee (TAC) of a limit of 0.1% by weight for lead hexavalent chromium, mercury, PBBs and PBDRs and 0.01% by weight for Cadmium.